

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

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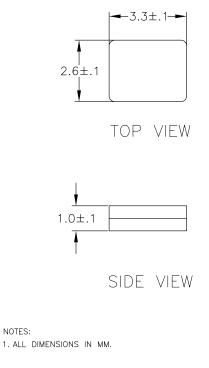


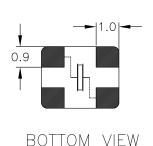
### **DATASHEET**

## **Specifications**

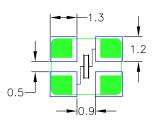
Parameters	Ratings/Units			
Frequency	40.000 MHz			
Resonance Mode	Fundamental			
Frequency Tolerance @ 25°C	±20 PPM Max			
Frequency Stability, ref @ 25°C Over Operating Temperature Range	±20 PPM Max			
Temperature Range, Operating (TOPR)	-40°C ~ +85°C			
Temperature Range, Storage (TSTG)	-40°C ~ +85°C			
Equivalent Series Resistance (ESR)	30 Ohms Max			
Shunt Capacitance (Co)	5 pF Max			
Load Capacitance (CL)	12 pF			
Drive Level	0.3 mW Max			
Aging over 10 years	±10 PPM Max			
Maximum Soldering Temp / Time	260°C / 10 Seconds			
Moisture Sensitivity Level (MSL)	1			
Termination Finish:	Au			
Weight (TYP)	16.75 mg			
RoHS Compliant, Pb-free				

## Package Outline and Dimensions (JA4)





## Package Outline and Dimensions (JA4), cont.



RECOMMENDED LAND PATTERN

#### NOTES:

- 1. ALL DIMENSION ARE IN mm. ANGLES IN DEGREES.

- 2. TOP DOWN VIEW. AS VIEWED ON PCB.
  3. COMPONENT OUTLINE SHOW FOR REFERENCE IN GREEN.
  4. LAND PATTERN IN BLUE. NSMD PATTERN ASSUMED.
  5. LAND PATTERN RECOMMENDATION PER IPC—7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

TOLERANCES UNLESS SPE DECIMAL XX± XXX± XXXX±		w w	IDT*	San Jose, PHONE: (4	er Creek Vo CA 95138 08) 727-6 ) 492-8674	16
APPROVALS	DATE	TITLE JA4 PACKAGE OUTLINE				
DRAWN RAC	2/5/15	3.2 x 2.5 mm B00Y				
CHECKED	17.7.	1.0 mm Thick CLCC				
		SIZE	DRAWING No.			REV
		C	PSC-4499			01
		DO NO	OT SCALE DRAWING		SHEET 2	OF 2

### **Ordering Information**

Part / Order Number	Shipping Packaging	Package	Temperature
603-40-48JA4I	Cut-Tape	3.2 x 2.5 x 1.0 mm JA4 CLCC	-40 to +85 °C
603-40-48JA4I8	Tape and Reel	3.2 x 2.5 x 1.0 mm JA4 CLCC	-40 to +85 °C



#### **Corporate Headquarters** 6024 Silver Creek Valley Road San Jose, CA 95138 USA

#### Sales

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